

Nove pobude za delo v IEC – OKTOBER 2025

Referenčna oznaka	Naslov	Tehnični odbor	Odbor (SIST)
13/1979/NP	PNW 13-1979 ED1: Requirements for data integrity of EVSE measuring systems	TC 13	SIST/TC MEE
13/1980/NP	PNW 13-1980 ED1: Requirements for enabling data exchange between Smart Meter and EVSE	TC 13	SIST/TC MEE
13/1981/NP	PNW 13-1981 ED1: Metrological requirements for in-situ control of EVSE	TC 13	SIST/TC MEE
18A/510/NP	PNW 18A-510 ED1: Electrical installations in ships - Part xxx: Ship-to-shore connection cables of rated voltages up to and including 18/30 kV	SC 18A	NI AKTIVNO PODROČJE
2/2273/NP	PNW 2-2273 ED1: Part 27-7: Sealed winding test for insulation systems used in rotating electrical machines	TC 2	SIST/TC ERS
33/736/NP	PNW 33-736 ED1: DC filter capacitors for HVDC transmission system	TC 33	NI AKTIVNO PODROČJE
47/2968/NP	PNW 47-2968 ED1: Semiconductor devices-Neuromorphic devices - Part 6 : Evaluation method of basic characteristics in one transistor one memristor (1T1M) arrays	TC 47	NI AKTIVNO PODROČJE
47/2969/NP	PNW 47-2969 ED1: Semiconductor devices - Neuromorphic devices - Part 5: Evaluation method of endurance and retention in memristor devices	TC 47	NI AKTIVNO PODROČJE
47/2970/NP	PNW 47-2970 ED1: Semiconductor devices - Chip-scale testing for autonomous vehicles -Part 3: Thermal imagers	TC 47	NI AKTIVNO PODROČJE
47/2973/NP	PNW 47-2973 ED1: Semiconductor devices - Chip-scale testing for autonomous vehicles - Part 2: Optical performance of LiDAR	TC 47	NI AKTIVNO PODROČJE
47E/872/NP	PNW 47E-872 ED1: Semiconductor Devices - Part 16-XX: Microwave integrated circuits - Phase frequency detectors	SC 47E	NI AKTIVNO PODROČJE
62/568/NP	PNW 62-568 ED1: Management systems - Guidelines for incorporating ecodesign in the medical device sector	TC 62	NI AKTIVNO PODROČJE
62/571/NP	PNW 62-571 ED1: Medical devices – In silico technologies – Part 2: Credibility assessment of first-principles based methods	TC 62	NI AKTIVNO PODROČJE
65C/1369/NP	PNW 65C-1369 ED1: Industrial networks – Fieldbus specifications - Part 3-29: Data-link layer service definition – Type 29 elements	SC 65C	SIST/TC MOV
65C/1370/NP	PNW 65C-1370 ED1: Industrial networks – Fieldbus specifications – Part 4-29: Data-link layer protocol specification – Type 29 elements	SC 65C	SIST/TC MOV
65C/1371/NP	PNW 65C-1371 ED1: Industrial networks – Fieldbus specifications – Part 5-29: Application layer service definition – Type 29 elements	SC 65C	SIST/TC MOV

65C/1372/NP	PNW 65C-1372 ED1: Industrial networks – Fieldbus specifications – Part 6-29: Application layer protocol specification – Type 29 elements	SC 65C	SIST/TC MOV
65C/1373/NP	PNW 65C-1373 ED1: Industrial networks – Profiles – Part 2-23: Additional real-time fieldbus profiles based on ISO/IEC/IEEE 8802-3 - CPF 23	SC 65C	SIST/TC MOV
82/2518/NP	PNW TS 82-2518 ED1: Measurement specifications for research-level perovskite photovoltaic cells	TC 82	SIST/TC PVS
8C/153/NP	PNW TS 8C-153 ED1: Business Use Cases (BUCs) of Flexibility Services	SC 8C	NI AKTIVNO PODROČJE
91/2073/NP	PNW 91-2073 ED1: Thermography test method for printed circuit interconnection defects	TC 91	NI AKTIVNO PODROČJE
91/2074/NP	PNW 91-2074 ED1: Materials for circuit boards and other interconnecting structures - Part 3-X: Sectional specification set for unreinforced base materials, clad and unclad – Build-up film of defined dissipation factor (greater than 0,0050 and equal to or less than 0,0080 at 10 GHz) for rigid organic package substrate, unclad	TC 91	NI AKTIVNO PODROČJE
91/2075/NP	PNW 91-2075 ED1: Materials for circuit boards and other interconnecting structures - Part 3-X: Sectional specification set for unreinforced base materials, clad and unclad – Build-up film of defined dissipation factor (greater than 0,0080 and equal to or less than 0,0200 at 10 GHz) for rigid organic package substrate, unclad	TC 91	NI AKTIVNO PODROČJE
91/2077/NP	PNW 91-2077 ED1: Circuit Board 2D Barcode Marking Requirements	TC 91	NI AKTIVNO PODROČJE
CIS/F/911/NP	PNW CIS/F-911 ED1: Electromagnetic compatibility of appliances, electric tools and similar apparatus - Part 3: Limits and methods of measurement of electromagnetic emissions for professional equipment in commercial and light-industrial locations	CIS/F	SIST/TC EMC
JTC1-SC41/543/NP	PNW JTC1-SC41-543 ED1: Digital twin – Process and guidance for digital twin model construction	ISO/IEC JTC 1/SC 41	NI AKTIVNO PODROČJE
JTC1-SC43/183/NP	PNW TS JTC1-SC43-183 ED1: Information technology - Brain-computer Interfaces - Testing and post market surveillance protocols for non-medical BCIs	ISO/IEC JTC 1/SC 43	NI AKTIVNO PODROČJE
65C/1374/NP	PNW 65C-1374 ED1: Industrial networks – Profiles – Part 5-23: Installation of fieldbuses – Installation profiles for CPF 23	SC 65C	SIST/TC MOV
73/238/NP	PNW TS 73-238 ED1: Pressure calculation for electrical installations with rated voltages above AC 1 kV and their installation rooms in the event of an arc fault	TC 73	SIST/TC NTF

